



# AO3402, AO3402L (Green Product) N-Channel Enhancement Mode Field Effect Transistor

### **General Description**

The AO3402 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications. AO3402L( Green Product ) is offered in a lead-free package.

#### **Features**

 $V_{DS}(V) = 30V$ 

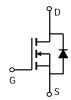
 $I_D = 4 A$ 

 $R_{DS(ON)}$  < 55m $\Omega$  (V<sub>GS</sub> = 10V)

 $R_{DS(ON)}$  < 70m $\Omega$  (V<sub>GS</sub> = 4.5V)

 $R_{DS(ON)}$  < 110m $\Omega$  ( $V_{GS}$  = 2.5V)





Absolute Maximum Ratings T <sub>A</sub> =25°C unless otherwise noted							
Parameter		Symbol	Maximum	Units			
Drain-Source Voltage		$V_{DS}$	30	V			
Gate-Source Voltage		$V_{GS}$	±12	V			
Continuous Drain	T <sub>A</sub> =25°C		4				
Current <sup>A</sup>	T <sub>A</sub> =70°C	$I_D$	3.4	Α			
Pulsed Drain Current <sup>B</sup>		$I_{DM}$	15				
	T <sub>A</sub> =25°C	$P_{D}$	1.4	W			
Power Dissipation A	T <sub>A</sub> =70°C	]' D	1	VV			
Junction and Storage Temperature Range		$T_J$ , $T_{STG}$	-55 to 150	°C			

Thermal Characteristics								
Parameter	Symbol	Тур	Units					
Maximum Junction-to-Ambient <sup>A</sup>	t ≤ 10s	В	70	90	°C/W			
Maximum Junction-to-Ambient A	Steady-State	$ R_{\theta JA}$	100	125	°C/W			
Maximum Junction-to-Lead <sup>C</sup>	Steady-State	$R_{\theta JL}$	63	80	°C/W			

#### Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units		
STATIC PARAMETERS									
$BV_{DSS}$	Drain-Source Breakdown Voltage	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V		30			V		
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =24V, V <sub>GS</sub> =0V				1	μА		
			T <sub>J</sub> =55°C			5	μΛ		
$I_{GSS}$	Gate-Body leakage current	$V_{DS}$ =0V, $V_{GS}$ =±12V				100	nA		
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_D=250\mu A$		0.6	1	1.4	V		
$I_{D(ON)}$	On state drain current	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =5V		10			Α		
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS}$ =10V, $I_{D}$ =4A	_		45	55	mΩ		
			T <sub>J</sub> =125°C		66	80	11122		
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =3A			55	70	mΩ		
		$V_{GS}$ =2.5V, $I_D$ =2A		83	110	mΩ			
g <sub>FS</sub>	Forward Transconductance	$V_{DS}$ =5V, $I_D$ =4A			8		S		
$V_{SD}$	Diode Forward Voltage	I <sub>S</sub> =1A,V <sub>GS</sub> =0V		0.8	1	V			
Is	Maximum Body-Diode Continuous Current					2.5	Α		
DYNAMIC	PARAMETERS								
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =15V, f=1MHz			390		pF		
C <sub>oss</sub>	Output Capacitance				54.5		pF		
C <sub>rss</sub>	Reverse Transfer Capacitance				41		pF		
$R_g$	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz			3		Ω		
SWITCHII	NG PARAMETERS								
$Q_g$	Total Gate Charge	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =15V, I <sub>D</sub> =4A			4.34		nC		
$Q_{gs}$	Gate Source Charge				0.6		nC		
$Q_{gd}$	Gate Drain Charge				1.38		nC		
t <sub>D(on)</sub>	Turn-On DelayTime				3.3		ns		
t <sub>r</sub>	Turn-On Rise Time	$V_{GS}$ =10V, $V_{DS}$ =15V, $R_L$ =3.75 $\Omega$ ,			1		ns		
$t_{D(off)}$	Turn-Off DelayTime	$R_{GEN}$ =6 $\Omega$			21.7		ns		
t <sub>f</sub>	Turn-Off Fall Time	1			2.1		ns		
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> =4A, dI/dt=100A/μs			12		ns		
$Q_{rr}$	Body Diode Reverse Recovery Charge	I <sub>F</sub> =4A, dI/dt=100A/μs			6.3		nC		

A: The value of  $R_{\theta,JA}$  is measured with the device mounted on  $1\text{in}^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A$  =25°C. The value in any a given application depends on the user's specific board design. The current rating is based on the t≤ 10s thermal resistance rating

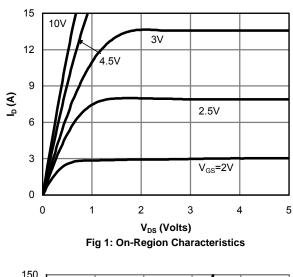
- B: Repetitive rating, pulse width limited by junction temperature.
- C. The R  $_{\theta JA}$  is the sum of the thermal impedence from junction to lead R $_{\theta JL}$  and lead to ambient.
- D. The static characteristics in Figures 1 to 6,12,14 are obtained using  $80\,\mu s$  pulses, duty cycle 0.5% max.
- E. These tests are performed with the device mounted on 1 in  $^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A$ =25°C. The SOA curve provides a single pulse rating.

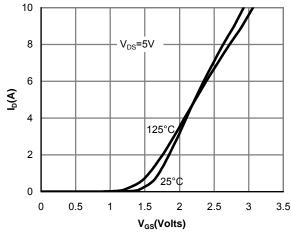
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#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





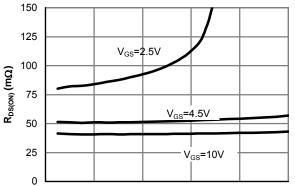
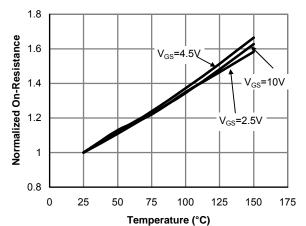


Figure 2: Transfer Characteristics



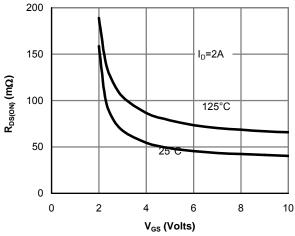
 $\label{eq:ID} {\rm I_D}\left({\rm A}\right)$  Figure 3: On-Resistance vs. Drain Current and Gate Voltage

6

8

10

Figure 4: On-Resistance vs. Junction Temperature



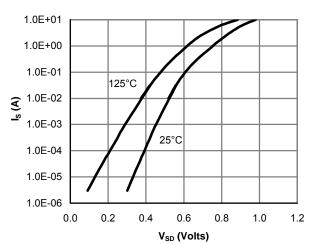


Figure 5: On-Resistance vs. Gate-Source Voltage

Figure 6: Body-Diode Characteristics

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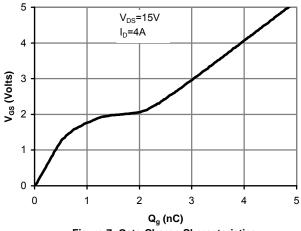


Figure 7: Gate-Charge Characteristics

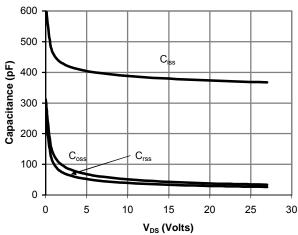


Figure 8: Capacitance Characteristics

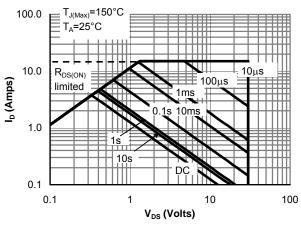


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

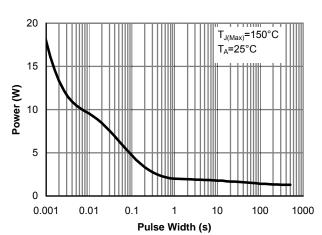


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

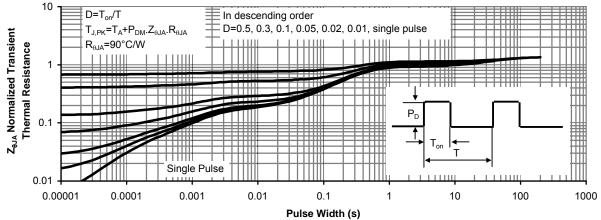


Figure 11: Normalized Maximum Transient Thermal Impedance



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